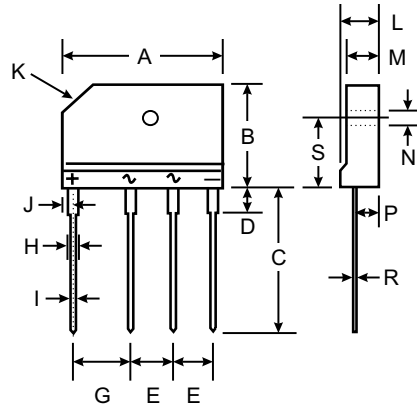


### Features

- Glass Passivated Die Construction
- High Case Dielectric Strength of 1500VRMS
- Low Reverse Leakage Current
- Surge Overload Rating to 240A Peak
- Ideal for Printed Circuit Board Applications
- Plastic Material - UL Flammability Classification 94V-0
- UL Listed Under Recognized Component Index, File Number E94661

### Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads, Solderable per MIL-STD-202, Method 208
- Polarity: Molded on Body
- Mounting: Through Hole for #6 Screw
- Mounting Torque: 5.0 in-lbs Maximum
- Weight: 6.6 grams (approx)
- Marking: Type Number



| GBJ                  |           |       |
|----------------------|-----------|-------|
| Dim                  | Min       | Max   |
| A                    | 29.70     | 30.30 |
| B                    | 19.70     | 20.30 |
| C                    | 17.00     | 18.00 |
| D                    | 3.80      | 4.20  |
| E                    | 7.30      | 7.70  |
| G                    | 9.80      | 10.20 |
| H                    | 2.00      | 2.40  |
| I                    | 0.90      | 1.10  |
| J                    | 2.30      | 2.70  |
| K                    | 3.0 X 45° |       |
| L                    | 4.40      | 4.80  |
| M                    | 3.40      | 3.80  |
| N                    | 3.10      | 3.40  |
| P                    | 2.50      | 2.90  |
| R                    | 0.60      | 0.80  |
| S                    | 10.80     | 11.20 |
| All Dimensions in mm |           |       |

### Maximum Ratings and Electrical Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

Single phase, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

| Characteristic  | Symbol   | GBJ 15005   | GBJ 1501 | GBJ 1502 | GBJ 1504 | GBJ 1506 | GBJ 1508 | GBJ 1510 | Unit             |
|---|--|-------------|----------|----------|----------|----------|----------|----------|------------------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                            | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 50          | 100      | 200      | 400      | 600      | 800      | 1000     | V                |
| RMS Reverse Voltage   | V <sub>R(RMS)</sub>                                    | 35          | 70       | 140      | 280      | 420      | 560      | 700      | V                |
| Average Forward Rectified Output Current @ T <sub>C</sub> = 100°C   | I <sub>O</sub>   | 15          |          |          |          |          |          |          | A                |
| Non-Repetitive Peak Forward Surge Current, 8.3 ms single half-sine-wave superimposed on rated load (JEDEC method) | I <sub>FSM</sub>                                       | 240         |          |          |          |          |          |          | A                |
| Forward Voltage (per element) @ I <sub>F</sub> = 7.5A DC  | V <sub>FM</sub>  | 1.05        |          |          |          |          |          |          | V                |
| Peak Reverse Current @ T <sub>C</sub> = 25°C<br>at Rated DC Blocking Voltage @ T <sub>C</sub> = 125°C             | I <sub>R</sub>   | 10<br>500   |          |          |          |          |          |          | μA               |
| I <sup>2</sup> t Rating for Fusing (t < 8.3ms) (Note 1)   | I <sup>2</sup> t                                       | 240         |          |          |          |          |          |          | A <sup>2</sup> s |
| Typical Junction Capacitance per Element (Note 2)   | C <sub>j</sub>   | 60          |          |          |          |          |          |          | pF               |
| Typical Thermal Resistance, Junction to Case (Note 3)   | R <sub>θJC</sub>                                       | 0.8         |          |          |          |          |          |          | °C/W             |
| Operating and Storage Temperature Range   | T <sub>j</sub> , T <sub>STG</sub>                      | -65 to +150 |          |          |          |          |          |          | °C               |

- Notes:
1. Non-repetitive, for t > 1ms and < 8.3 ms.
  2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
  3. Thermal resistance from junction to case per element. Unit mounted on 300 x 300 x 1.6mm copper plate heat sink.

